Company Introduction 2024

CKEMSOLUTION



01 COMPANY OVERVIEW

CKEMS Introduction



Company overview



Company Name	CK EMSolution Co., Ltd.
CEO	YANG KWANG-YONG
Date of Establishment	2021.10.01
Capital	5.6 billion won
number of Employees	40 (2023.11)
Business Area	Thermal Interface Adhesive Coating Solution Eletronic Material and Coating Solution
Location Site	 KOR: 58, Daepungsandan-ro, Daeso-myeon, Eumseong-gun, Chungcheongbuk-do, Republic of Korea USA: 259 Casablanca Dr, Macon, GA 31217 USA HUN: Heves, Egri u. 26, 3360 Hungary
Parent Company	CHO KWANG PAINT





Global Supply Chain



KOR, USA, HUN FACTORY
OPERATIONS SETUP COMPLETED

CORE BIZ.



TIM

THERMAL INTERFACE MATERIAL

PARENTS COMPANY

USAGE DOWN, EFFICIENCY UP.

TIM SECTOR BOASTS ALL SOLUTIONS

Competitiveness



CHOKWANG PAINT

Lightweight &

High Efficiency

A COMPREHENSIVE PAINT COMPANY WITH A HISTORY OF 78 YEARS

ESTABLISHMENT



2021

AFTER PRODUCT DEVELOPMENT, ESTABLISHMENT OF A CORPORATION, WITH 100% INVESTMENT FROM THE PARENT COMPANY

BRAND



NOVASOLIS

CK EM SOLUTION'S PROPOSED 'NEW FUTURE' BI REGISTRATION



U2 Company History

CK EM Solution, established as a subsidiary of Chokwang Paint after completing incubating development for new growth engines

1947~2016

ChoKwang Paint Growth



1947 Establishment of **Chokwang Paint** 1988 Establishment of Chokwang Jotun, a joint venture with Jotun in Norway 2016 Presidential Commendation for Fair Trade Day

2012~2020

New Business Development



2012 Development of LG Chem's urethane and hardener 2018 Supply of LG Chem's urethane (~ until 2020) 2020 Establishment of TFT Team for Heat Dissipation and Commencement of **Urethane TA Development**

2021~2023

CKEMS Setup



2021 The high-hardness urethane TA module tests are completed (both for 1w and 2w) 2021 Establishment of CKEMS_KOR, USA, HUN 2022 KOR, HUN Factory Completion 2023 USA Factory Completion

2023 ~

Business ramp up



2023 Urethane TIM Low-hardness module 3 Site IATF 16949 3 Site Factories Set-up completed VDA 6.3 in progress

Certification & Patents



IATF16949(Automotive Quality Management) Certification approved

Category	KOR	HUN	USA	
Certification Date	2023.02.19	2023.03.03	2023.08.24	
Certification NO.	0468702-LOC	0469807-LOC	0481922-LOC	

KSA STANDARDS ASSOCIATION

CK EM SULUTION 58, DAEPUNGSANDAN-GUN, CHUNGCHEONGBU

The Quality Management and scope detailed below.

> SITE NAME: CK EM SUL SITE ADDRESS: 58, EUMSEONG-GUN, CHUY

REMOTE FUNCTION: REVIEW, INTERNAL AU REVIEW, SALES, LOGE SUPPLIER MANAGEMEN

STANDARD: IATE 16949 CONFORMANCE SCO ADHESIVE FOR SECONI (EXCLUSION: NONE)

IATF LoC No.: 0468702-L KSA LoC No.: 0468702-Lo VALID DATE: 18 Februar ISSUE DATE: 19 February

The purpose of issuance of but does not have one full of

CK EM SOLUTION HUN Kft 3360 Egri ut 26, Heves, Hungary

The Quality Management System of the ab been assessed and found to meet the requirer and scope detailed below.

> SITE NAME: CK EM SOLUTION HUN KIT. SITE ADDRESS: 3360 Egri ut 26, Heves, Hungary

REMOTE FUNCTION: PRODUCT DESIGN STRATEGIC PLANNING, MANAGEMENT REV MANAGEMENT, TRAINING, CONTRACT 1 SUPPLIER MANAGEMENT

STANDARD: IATF 16949:2016 CONFORMANCE SCOPE: DESIGN AND ADHESIVE FOR SECONDARY BATTERY MOI (EXCLUSION: NONE)

IATF LoC No.: 0469807-LoC(USI: TNCRKY) KSA LoC No.: 0469807-LoC VALID DATE: 03 March 2024 ISSUE DATE: 03 March 2023

The purpose of issuance of this letter is to confirm quality management system which satisfies the requi-but does not have one full cycle of production and pe

CK EM SOLUTION USA INC.

259 CASABLANCA DR, MACON, GEORGIA, 31217 USA

The Quality Management System of the above organization has been assessed and found to meet the requirements of the standard and scope detailed below.

SITE NAME: CK EM SOLUTION USA INC.

SITE ADDRESS: 259 CASABLANCA DR, MACON, GEORGIA, 31217 USA

REMOTE FUNCTION: PRODUCT DESIGN, PROCESS DESIGN, STRATEGIC PLANNING, MANAGEMENT REVIEW, INTERNAL AUDIT MANAGEMENT, TRAINING, CONTRACT REVIEW, PURCHASING, SUPPLIER MANAGEMENT

STANDARD: IATE 16949:2016

CONFORMANCE SCOPE: DESIGN AND MANUFACTURE OF ADHESIVE FOR SECONDARY BATTERY MODULE AND PACK (EXCLUSION: NONE)

IATF LoC No.: 0481922-LoC(IATF USI: GX449T) KSA LoC No.: LOC-0006

VALID DATE: 28. August, 2024 ISSUE DATE: 29 August 2023

The purpose of issuance of this letter is to confirm that the organization has the quality management system which satisfies the requirements of IATF 16949:2016, but does not have one full cycle of production and performance data.

Myssokary

Korean Standards Association

Held Patents

Category	Patents No.	특허명	
Patent	No. 10-1736898	"Composition of Coating Material for Electromagnetic Shielding"	
Patent	No. 10-1958240	"UV-curable coating composition for electromagnetic shielding film protection"	
Patent	No. 10-2397281	"Lightweight Heat-dissipating Adhesive Composition and its Manufacturing Method"	
Patents	No. 10-2457897	"Thermally Conductive Adhesive Composition with Low Dielectric Properties and its Manufacturing Method"	









*BI registration:

NOVASOLIS domestic trademark registration, European Madrid trademark registration completed



04 Global Networks



As a proactive Investment for entering the global market, Preparation for overse as subsidiary production completed



CK EM SOLUTION KOREA

58, Daepungsandan-ro, Daeso-myeon, Eumseon g-gun, Chungcheongbuk-do, Republic of Korea

TEL: +82-43-530-1500







CK EM SOLUTION HUNGARY

Heves, Egri u. 26, 3360 Hungary TEL: +36-30-099-5244





CK EM SOLUTION USA

259 Casablanca Dr, Macon, GA, 31217 USA TEL: +1-478-342-6009





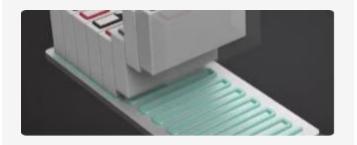
Products Portfollo



Providing customizied TIM Solution to Customers

Product 1

Urethan TIM



Application

 Secondary Battery Module and Pack

Function

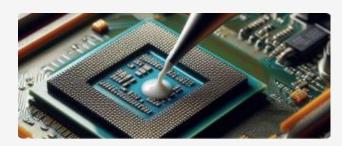
- Attaching battery cells and heat sinks
- · External Vibration
- · Shock Protection
- · Rapid Heat Transfer of Battery
- · Maintaining BatteryTemperature

Edge

- · Low weight, lightweighting
- · Excellent thermal conductivity
- · cost save

Product 2

Liquid Silicone TIM



Application

Secondary Battery Pack
 Automotive Electric Part,
 DC-DC Converter

Function

- · Attaching Battery Modules and Sub-cooling Plates for Heat Transfer
- · Attaching heat sinks and PCB com ponents for heat transfer

Edge

- · Low weight, lightweighting
- · Excellent thermal conductivity
- · cost save

Product 3

Silicone TIM PAD



Application

· CPU, IGBT unit, and heat-generating electronic components

Function

- · Thermal Management of Electron ic Components
- · Extending Lifespan & Maintaining Performance of Electronic Devices"

Edge

- · High flexibility
- · High insulation

Pruduct 4

Epoxy TIM



Application

· Energy Storage System (ESS)

Function

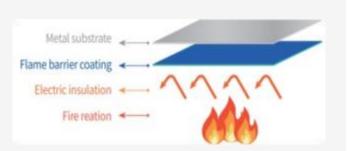
- · Peak Power Management
- · Attachment of ESS Modules and P acks
- Heat Dissipation and Protection o f Modules and Packs

Edge

· Excellent Weathering resistance

Product 5

Flame barrier coating



Application

- · Battery case for secondary batteri es
- · Busbar Frame

Function

- · Possibility curable on the room te mperature
- · Possibility Fire Resistance Perfor mance in Various Materials
- · After exposure to flames, maintai ning insulation performance

Edge

· Excellent Impact resistance

02

OUR COMPETITIVENESS

CKEMS 's Competitiveness

- 1) VISION
- 2) R&D capability
- 3) TIM specialist company
- 4) Low weight, High efficiency

VISION



"Global Leading Total Solution Provider in Electrical & Electronic Materials"



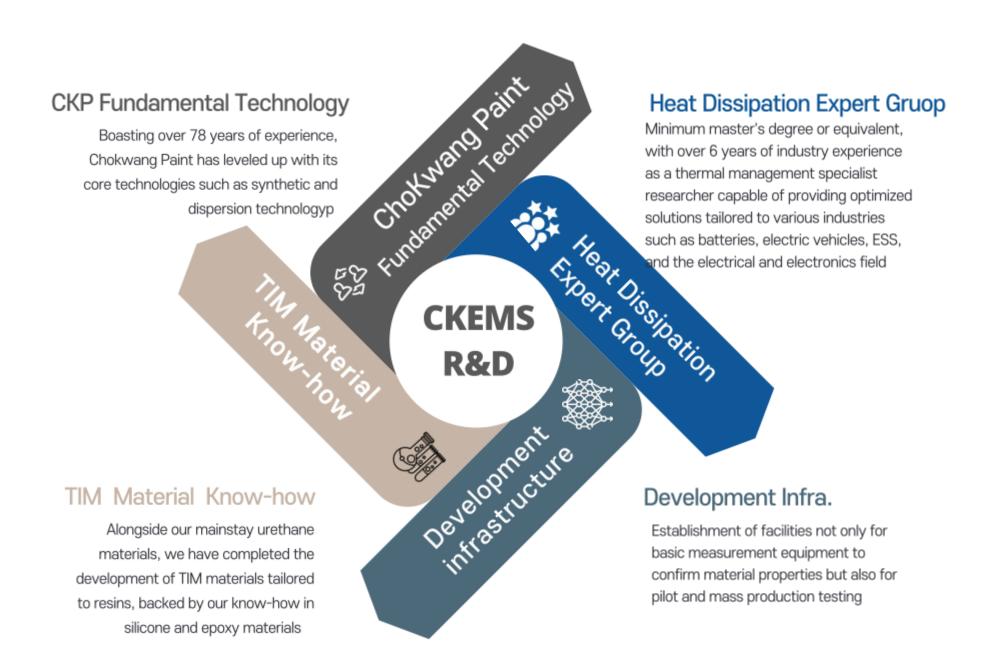
CK EM Solution Co., Ltd. is a specialized company in the field of electric/electronic materials solutions, based on precision synthesis technology and material application expertise

EMS Competitiveness





Providing customers with the most optimized solutions through material technology and application field know-how



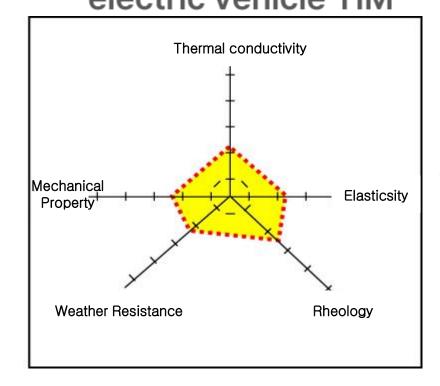


EMSOLUTION

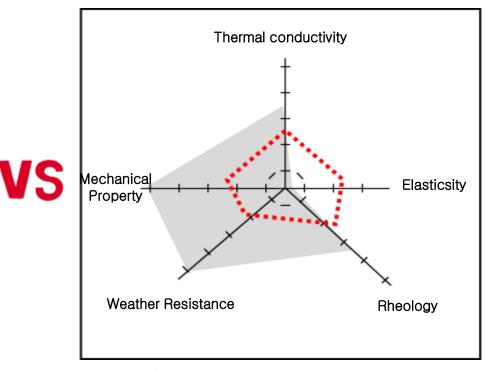
EMS Competitiveness 2 TIM specialist company

CK EMS possesses excellent Know-how in TIM materials

Required characteristics for electric vehicle TIM

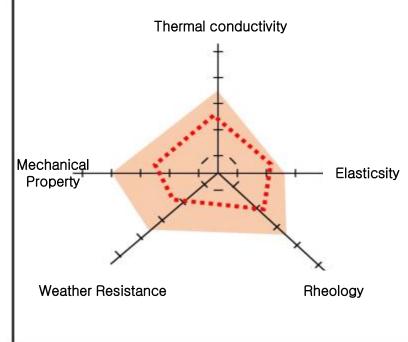


Ероху



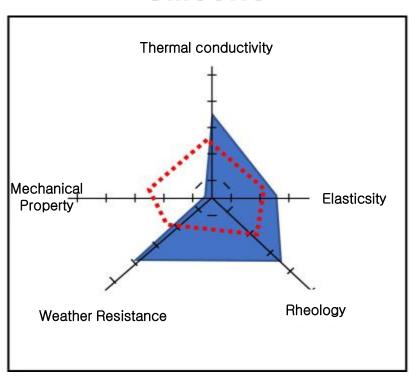
 Application : Energy Storage System (ESS)

Urethane



Application :
 Secondary Battery
 Module and Pack
 Transitioning from Silicone
 GapFiller to Urethane TIM

Silicone



Application :
 Secondary Battery Pack
 Automotive Electric Part,
 DC-DC Converter

Mplementing the optimization of the required characteristics for electric vehicles through CKEMS's expertise

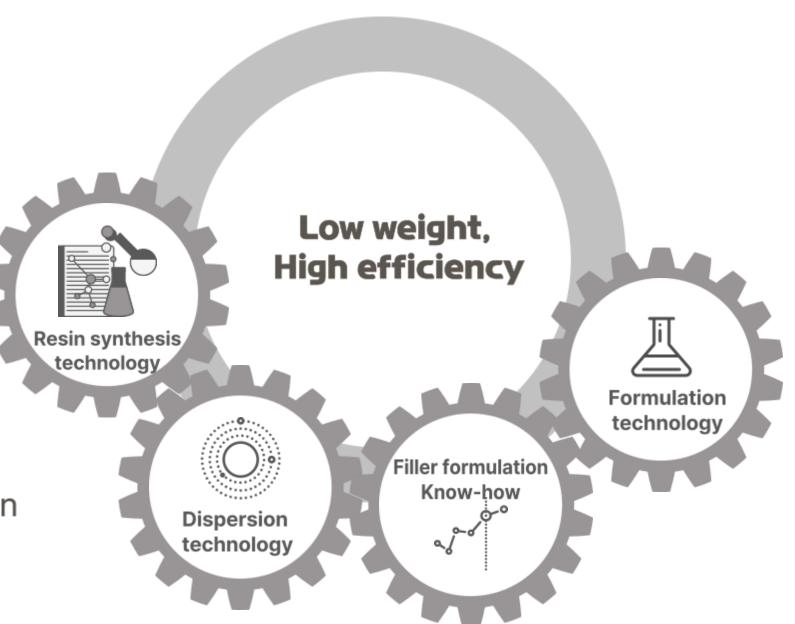
EM

EMS Competitiveness 3 Low weight, High efficiency

Through the implementation of low weight, high efficiency technology, provide benefits to customers such as lightweighting and cost savings

ITEM	Existing product (2W/mk)	Our product (2W/mk)	Improvement Effect
Specific Gravity (g/ml)	2.5	2.1	16%
Cooling Effciency (△T/W)	1.31	1.01	Cooling Efficiency up

- Low specific Gravity compared to competitors
- : When applied to the same volume, there is a 16% reduction in lightweight and cost savings effect
- Excellent cooling efficiency
- : Extended battery lifespan with the same battery usage



EMSOLUTION

EMS Competitiveness 4 Overseas subsidiary Ready to...

Preparation for overseas subsidiary(USA, HUN) production completed

Macon Plant/USA



- Location: Macon, Georgia, USA
- Total Area : 29,126m²
- * 1 Factory : Area 10,000m², Building 3,157m², Max.Capa. 3,500tons/year
- * 2 Factory : Area 7,060m², Building 8,910m², Max. Capa. 24,000tons/year등

Heves Plant/HUN



- Location: Heves, Hungary
- Total Area: 34,000m²
 - *1 Factory : Area 10,000m2, Building 3,8066m², Max. Capa. 3,000ton/year
 - *2 Factory : Area 13,000m², Building 3,420m², Max. Capa. 3,000ton/year
 - 3 Factory : Area 11,000m²

Eumseong HQ/KOR



- Located in Daeso-myeon, Eumseong-gun, Chungcheongbuk-do-Chokwang Paint (Eumseong) Factory
- Manufacturing Space: 14,877m²
- Capa.: 300tons

03 OUR PRODUCTS

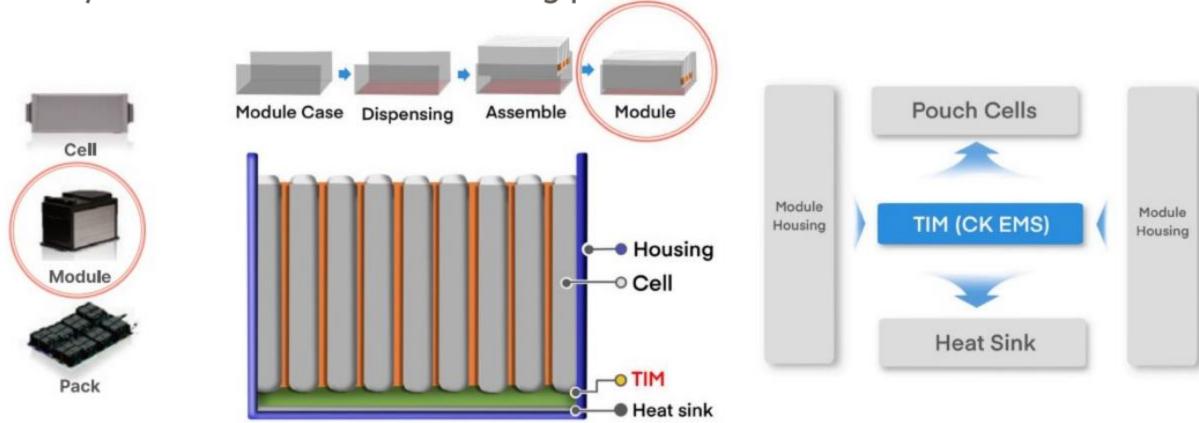
CKEMS 's Products



Urethane TIM

- · 2K adhesive composed of polyol resin and isocyanate
- · Solvent free type adhesive cured at room temperature
- · Applied to the device which requires the heat management by thermal conductive performance
- · Excellent thermal conductivity, weather resistance, durability, mechanical and electrical properties

Excellent workability with 1:1 volume ratio mixing process



EM

Urethane TIM

CKE-TAU-102 1W High hardness type

Requirement	Unit	Function	Requirement	Result	Test Methodology
Color (Base/Hardener)	-	-	-	Green/White	
Operating Temperature	°C	OEM Require	-40° C ~ 85° C	-40 ~ 85	-
Base Material	-	-	Urethane (Epoxy, Silicone)	Urethane	-
Mix Ratio	-	OEM Require	1:1	Volume ratio 1 : 1	-
Density (Base/Hardener)	g/ml	Module Weight	≤ 2.1 (Mix)	1.95 (Mix)	ASTM D1475
Viscosity (Resin/Hardener/Mixture)	Pa.s	Utility Requirement	Anton-Paar rheometer	535 / 508 / 552 (@1/s)	ASTM D2196
Thixotropic Index (Base/Hardener)	-	Utility Requirement	≥ 2.5	3.88 / 3.12 / 3.61	ASTM D2196
Working Time (2X Viscosity)	Min	Production	≥ 30	31	ASTM D2196
Handling Time (1MPa)	Hour	Quality Requirement	≤ 10	4	ASTM D1002
Curing Time (LSS기준)	Houl	Quality Requirement	≤ 48	41	ASTM D1002
Shrinkage	%	-	-	0	-
Thermal Conductivity (Thickness 5mm)	W/mK	Thermal Performance	≥ 1	1.32	ISO 22007-2
Hardness (Thickness 6mm)	Shore D	Pouch Damage	55	52	ASTM D2240
Lap Shear Strength (Thickness 0.3mm)	MPa	Vibration/ Shock	Avg. 10 (기준시편) Avg. 7.5 (SKI 시편) Avg. 2000 (기준시편)	10.22 (기준시편)	ASTM D1002
Peel Strength (Thickness 0.3mm)	gf/cm	Adhesion	Avg. 2000 (기준시편) Avg. 750 (SKI 시편)	2600 (기준시편)	ASTM D903
Volume Resistance (Thickness 1mm)	Ohm.cm	Insulation	≥ 10^13	2.47X10 ¹³	ASTM D257
Surface Resistance (Thickness 0.3mm)	Ohm.sq	Insulation	≥ 10^13	3.34X10 ¹⁴	ASTM D257
Breakdown Voltage (Thickness 0.3mm)	kV/mm	Insulation	≥ 10	21.2	ASTM D149
Flammability (Thickness 3mm)	-	OEM Require	VO	V0	UL V-, VTM- Test
Dielectric Constant (Thickness 3mm)	-	Module/System Y-Capacitance	≤ 9 (@1kHz) ≤ 7 (@1MHz)	6.93 (@1kHz) 5.60 (@1MHz)	ASTM D150
TGA Residue (Resin/Hardener)	%	-	< 55	49.3 / 54.1	800℃ residue weight%

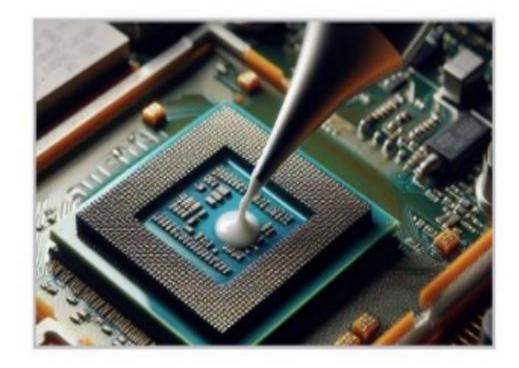
CKE-TAU-104 1W Low hardness type

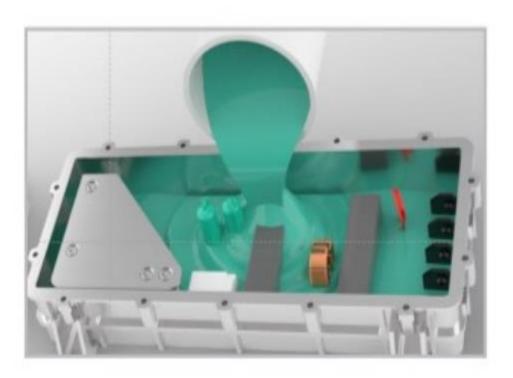
Test item		Test	Unit	Storage period	
		Methodology	Oilit	Target	Properties
LOT No. (Base / Hardener)		-	-		(230524B2 / 230524H2)
	Base				1.95
1. Density (Resin / Hardener)	Hardener	ASTM D1475	g/ml	< 1.95	1.95
	Mix				1.95
	Base				348
2-1. Viscosity (@0.5/1/5/s)	Hardener	ASTM D2196	Pa.s	350 ~ 400	359
,,	Mix				357
	Base				3.34
2-2 Thixotropic index (@0.55 ⁻¹ /55 ⁻¹)	Hardener	ASTM D2196	-	> 2.5	2.88
(@0.55 /55 /	Mix				2.87
3. Working Time		ASTM D2196	min	> 50	Min. 55.8
					Min. 54
4. Hardness		ASTM D2240	Shore A	50 ~ 60	Max. 55
5. Shrinkage rate			96	< 0.5	0.17
6. Thermal Conductivity		ISO 22007-2	W/mK	1.0 ~ 1.4	1.15
7. Lap Shear Strength		ASTM D1002	MPa	> 1.5	Avg. 2.32
8. Peel Strength		ASTM D903	gf/cm	> 400	Avg. 751
9-1. Elastic modulus		ASTM D638, Type 4	MPa	< 5	2.97 (0.5~3%) 2.59 (0.5~5%)
9-2. Elongation		ASTM D638, Type 4	96	> 220	253
10-1. Curing time		ASTM D1002	hours	< 48	< 48
10-2. Handling time		ASTM D1002	hours	< 8	< 8
11-1. Volume Resistano	e	ASTM D257	Ohm.cm	> 10^11	1.06^11
11-2. Surface Resistance	e	ASTM D257	Ohm.sq	> 10^12	1.70^12
11-3. Breakdown Voltag	ge	ASTM D149	kV/mm	> 10	17.1
42 Birladi		ACTIV DATE		< 6.2 (1kHz/1V)	5.5
12. Dielectric constant		ASTM D150	-	< 5.8 (1MHz/1V)	5.1
13. Flammability		UL V-,	-	vo	VO
14. Thixotropy		VTM- Test ASTM D2202	mm		3.15
15. TGA residue (Resin/Hardener)		800°C residue weight%	96	< 60	Base 54.5 Hardener 55.2

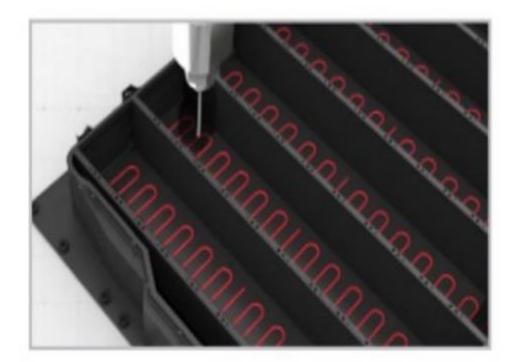


Liquid Silicone TIM

· A product composed of polyvinylsiloxane and hybrid. It provides 1K type grease and 2K(2components) type TIM products. There are no by-products caused by the addition reaction and it can be applied to all parts that require thermal management because of the advantage of fast hardening at room temperature











02 Liquid Silicone TIM

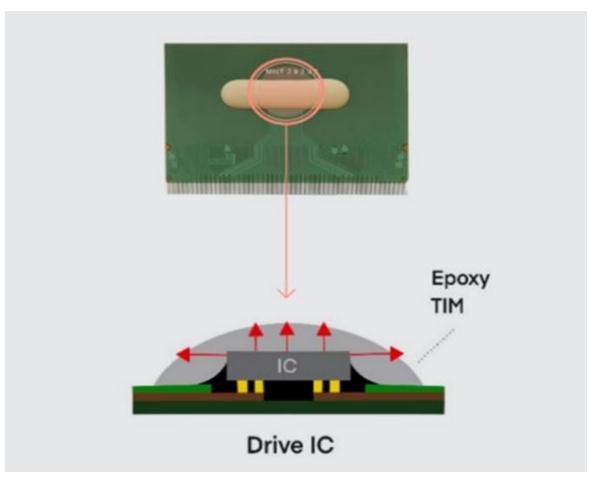
	TGS-C2002	TGS-C3002	Test methodology
Density	2.7 ± 0.2	2.1 ± 0.2	ASTM D1475
Viscosity (Pa·s)	200 ~ 400	200 ~ 400	ASTM D2196
Ratio (Base : Hardener)	1:1	1:1	Volume ratio
Thermal conductivity (W/mK)	3.0	3.0	ASTM D7984
Volume resistance (Ωcm)	> 1 x 10 ¹³	> 1 x 10 ¹³	ASTM D257
Breakdown voltage (kV/mm)	13	15	ASTM D149
Frammability	V0	VO	UL-94

EM

Epoxy TIM

- · Adhesive composed of epoxy resin and hardener
- · Applied to the device which requires the heat management by thermal conductive performance
- · Excellent thermal conductivity, weather resistance, durability, mechanical and electrical properties
- · Applied to fields requiring reliability (energy storage devices, Drive IC)





03 Epoxy TIM

	TAE-C	CR001	
	Base	Hardener	Test methodology
Viscosity (Pa.s)	150±50	200±50	ASTM D2106
Mix Viscosity (Pa.s)	150 ± 30		ASTM D2196
Density	2.4	2.4	ASTM D1475
Thermal conductivity (W/mK)	3.0		ISO 22007-2
Flammability	V0		UL V-, VTM- Test
Hardness	50 ~ 70		ASTM D2240
Lap shear strength (Mpa)	5.6		ASTM D1002
Volume resistance (Ωcm)	8.6 × 10^10		ASTM D257



Silicone PAD

• It is a heat dissipation material that transfers heat generated from electronic devices, internal combustion engine vehicles, EVs, etc. to the outside. It is mixed with silicone resin and the heat conductive filler and is customized to meet the customer's needs.

